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U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office

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1. 03.01	Attorney Docket No.: 041993-5149
To the Commissioner for Patents: Please record the attached original documents or copy thereof.	ATTN: BOX ASSIGNMENT
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):
Soon-Hong HWANG	Name: Hyundai Electronics Industries Co., Ltd.
Additional name(s) of conveying party(ies) attached? YesX No	Internal Address:
3. Nature of conveyance: _X Assignment Merger	Street Address: San 136-1, Ami-Ri, Bubal-Eub, Ichon-Shi, Kyoungki-Do, Korea
Security Agreement Change of Name Other	City: State: Zip:
Execution Date: 09/167263	Additional name(s) & address(es) attached? Yes X No
A. Patent Application No.(s) Additional numbers attached:YesX No	
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1
Name: William O. Trousdell	7. Total fee (37 C.F.R §3.41): <u>\$40.00</u>
Internal Address: Morgan, Lewis & Bockius LLP Customer No. 009629	X Enclosed Authorized to be charged to deposit account 50-0310
Street Address: 1800 M Street, N.W. City: Washington State: D.C. Zip: 20036	Deposit account number: 50-0310 Attach duplicate of page if paying by deposit account
9. Statement and Signature	
To the best of my knowledge and belief, the foregoing infortune original document.	mation is true and correct and any attached copy is a true copy of
William O. Trousdell Name of Person Signing William O. Trousdell Signa	ture Bute
Total number	of pages including cover sheet, attachments and documents:

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1-WA/1546673.1

PATENT REEL: 011478 FRAME: 0773

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

METHOD FOR FABRICATING SEMICONDUCTOR CAPACITOR

for which I/WE executed an application for United States Letters Patent concurrently herewith; or fi	iled an application for United		
WHEREAS, <u>Hyundai Electronics Industries Co., Ltd.</u> , a corporation of <u>Korea</u> , whose po <u>Arni-Ri, Bubal-Eub, Ichon-Shi, Kyoungki-Do, Korea</u> (hereinafter referred to as Assignee), is desirtitle, and interest in and to this invention, the application for United States Letters Patent on this invention upon this application;	ous of securing the entire right,		
NOW THEREFORE, be it known that, for good and valuable consideration the receipt of vacknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby secunto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and tapplication, and all divisions, and continuations thereof, and all Letters Patent of the United States wall reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trader all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms.	ell, assign, transfer, and set over to this invention and this which may be granted thereon, and marks of the United States to issue		
AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.			
AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No			
Full Name of Sole or First Assignor Soon-Hong HWANG Address: Uncheon-Jukong Apt. 109-404, 527, Shinbong-Dong, Hungduk-Ku,	Date San. 6, 2001 Citizenship:		
Address: Uncheon-Jukong Apt. 109-404, 327, Shintening Cheongju, Choongcheonbuk-Do, Korea Names of additional inventors attached [] Yes [X] No	Republic of Korea		

Morgan, Lewis & Bockius LLP

1-WA/1512258.2

RECORDED: 01/23/2001

PATENT REEL: 011478 FRAME: 0774